

Jun. 23. 2005 5:56PM

No. 0259 P. 1

Atty. Docket No. CPAC 1029-7  
Appl. No. 10/681,584

RECEIVED  
CENTRAL FAX CENTER  
JUN 23 2005

PATENT

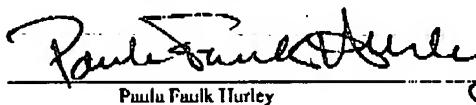
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Marcos Karnezos	)	Examiner: Alonzo Chambliss
Application No.: 10/681,584	)	Group Art Unit: 2814
Filed: October 8, 2003	)	Date: <u>23 June 2005</u> .
Title: Semiconductor multi-package module having inverted second package and including additional die or stacked package on second package	)	

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to Examiner Chambliss in the United States Patent and Trademark Office, at the Central Fax no. 703-872-9306 on June 23, 2005.

Signed



Paula Faulk Turley

RESPONSE TO OFFICE ACTION

Dear Sir:

Applicant responds as follows to the Office action mailed May 23, 2005 asserting Applicant's reply filed May 9, 2005 was "not fully responsive to the prior Office Action".

This Response supplies an omission or correction in the Applicant's reply to the prior Office action; Amendments to the Specification and to the Drawings, and the Remarks pertaining thereto, made in Applicant's reply to the prior Office action, are incorporated by reference herein.

There are no further amendments to the claims, beyond those made in Applicant's reply to the prior Office action. A Listing of Claims begins on page 2 of this paper.

Remarks begin on page 8 of this paper.